

Surface Mount Ultrafast Rectifier

ES1DAF, ES1JAF

Features

- Fast Switching Speed Maximum T_{rr} 35 ns
- Ultra Thin Profile Maximum Height of 1.0 mm
- Glass Passivated Junction
- UL Flammability 94V-0 Classification
- MSL 1
- Green Mold Compound
- These Devices are Pb-Free, Halogen Free Free and are RoHS Compliant

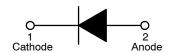
Specifications

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C unless otherwise noted)

		Value		
Symbol	Parameter	ES1DAF	ES1JAF	Unit
V_{RRM}	Recurrent Peak Reverse Voltage	200	600	V
V _{RMS}	RMS Voltage	140	420	V
V _R	DC Blocking Voltage	200	600	V
I _{F(AV)}	Average Forward Current	1		Α
I _{FSM}	Peak Forward Surge Current: 8.3 ms Single Half Sine-Wave Superimposed on Rated Load	30		Α
T _J	Operating Junction Temperature Range	-55 to +150		°C
T _{STG}	Storage Temperature Range	−55 to +150		°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

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Ultrafast Rectifier



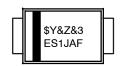
DO-214AD (SMAF) CASE 403AD

MARKING DIAGRAMS



Band Indicates Cathode

\$Y = onsemi Logo &Z = Assembly Plant Code &3 = Data Code (Year & Week) ES1DAF = Specific Device Code



Band Indicates Cathode

\$Y = onsemi Logo &Z = Assembly Plant Code &3 = Data Code (Year & Week) ES1JAF = Specific Device Code

ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet

ES1DAF, ES1JAF

THERMAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Symbol	Characteristic	Value	Unit
$\Psi_{\sf JL}$	Typical Thermal Characteristics, Junction-to-Lead (Note 1)	24	°C/W
$R_{\theta JA}$	Typical Thermal Resistance, Junction-to-Ambient (Note 2)	150	°C/W

^{1.} Mounted on an FR4 PCB, single-sided copper, with 48 ${\rm cm^2}$ copper pad area.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V _F	Forward Voltage	I _F = 1 A	ES1DAF	-	-	0.95	V
			ES1JAF	-	=	1.70	
I _R	Reverse Current	$V_R = V_{DC}$		-	-	1	μΑ
t _{rr}	Reverse Recovery Time	I _F = 0.5 A, I _R = 1 A, I _{rr} = 0.25 A		-	-	34	ns
CJ	Junction Capacitance	V _R = 4 V, f = 1 MHz		-	15	-	pF

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

ORDERING INFORMATION

Part Number	Top Mark	Package	Shipping [†]
ES1DAF	ES1DAF	DO-214AD (SMAF) (Pb-Free/Halogen Free)	10000 / Tape & Reel
ES1JAF	ES1JAF	DO-214AD (SMAF) (Pb-Free/Halogen Free)	10000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

^{2.} Mounted on an FR4 PCB, single-sided copper, mini pad.

ES1DAF, ES1JAF

TYPICAL PERFORMANCE CHARACTERISTICS

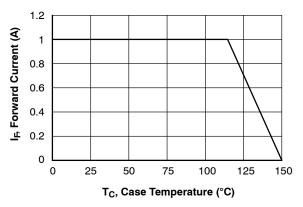


Figure 1. Forward Current Derating Curve

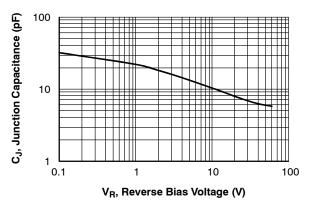


Figure 2. Typical Junction Capacitance

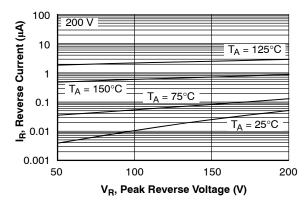


Figure 3. Typical Reverse Characteristics

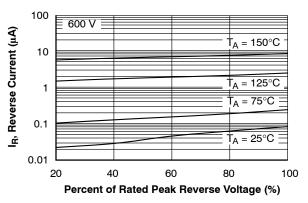


Figure 4. Typical Reverse Characteristics

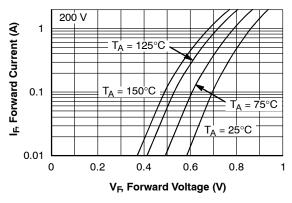


Figure 5. Typical Forward Characteristics

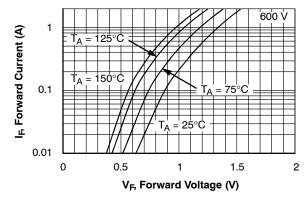


Figure 6. Typical Forward Characteristics



CATHODE IDENTIFIER

// 0.05 C



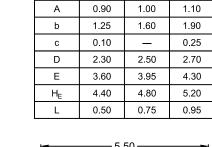
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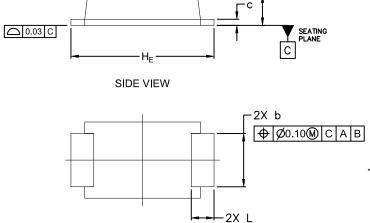
DATE 14 JUL 2020



- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2009. CONTROLLING DIMENSION: MILLIMETERS DIMENSIONS D & E ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR EXTRUSIONS.

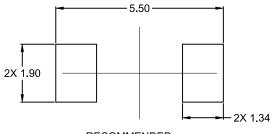
	MILLIMETERS			
DIM	MIN.	NOM.	MAX.	
Α	0.90	1.00	1.10	
b	1.25	1.60	1.90	
С	0.10	_	0.25	
D	2.30	2.50	2.70	
Е	3.60	3.95	4.30	
HE	4.40	4.80	5.20	
L	0.50	0.75	0.95	





TOP VIEW

BOTTOM VIEW



RECOMMENDED MOUNTING FOOTPRINT*

For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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